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Details	
Product Status	Active
Core Processor	S08
Core Size	8-Bit
Speed	8MHz
Connectivity	SCI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	39
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-LQFP (10x10)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=mc9s08re16fge

MC9S08RG60 Data Sheet

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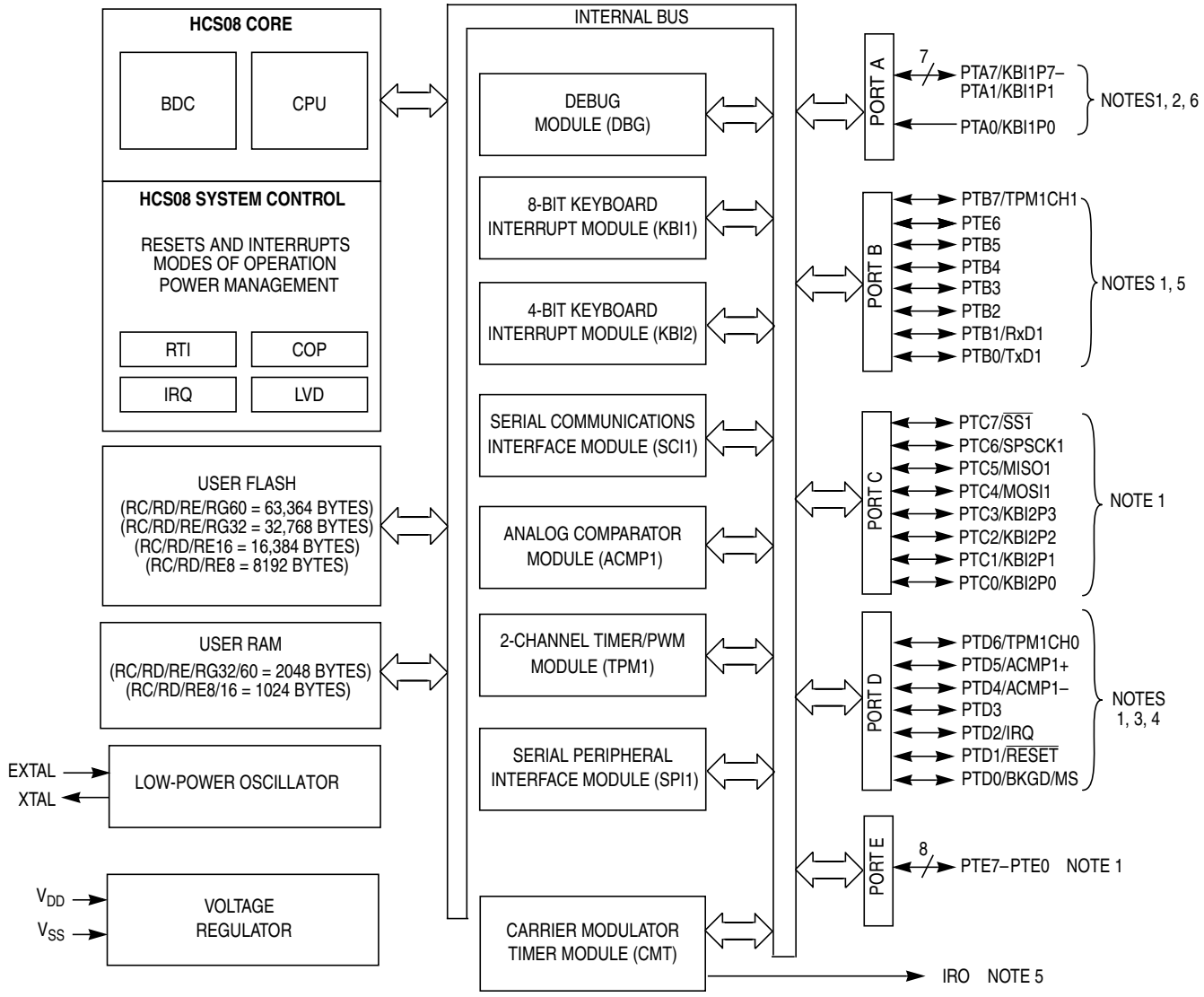
1.3 MCU Block Diagram

This block diagram shows the structure of the MC9S08RC/RD/RE/RG MCUs



NOTES:

1. Port pins are software configurable with pullup device if input port
2. PTA0 does not have a clamp diode to V_{DD}. PTA0 should not be driven above V_{DD}. Also, PTA0 does not pullup to V_{DD} when internal pullup is enabled.
3. IRQ pin contains software configurable pullup/pulldown device if IRQ enabled (IRQPE = 1)
4. The RESET pin contains integrated pullup device enabled if reset enabled (RSTPE = 1)
5. High current drive
6. Pins PTA[7:4] contain both pullup and pulldown devices. Pulldown enabled when KBI is enabled (KBIPEn = 1) and rising edge is selected (KBEDGn = 1).

Figure 1-1. MC9S08RC/RD/RE/RG Block Diagram

Table 1-2 lists the functional versions of the on-chip modules.

Table 2-1. Pin Sharing References

Port Pins	Alternate Function	Reference[1]
PTA7–PTA0	KBI1P7–KBI1P0	Chapter 9, “Keyboard Interrupt (S08KBIV1)”
PTB7	TPM1CH1	Chapter 10, “Timer/PWM Module (S08TPMV1)”
PTB6–PTB2	—	Chapter 6, “Parallel Input/Output”
PTB1 PTB0	RxD1 TxD1	Chapter 11, “Serial Communications Interface (S08SCIV1)”
PTC7 PTC6 PTC5 PTC4	SS1 SPSCK1 MISO1 MOSI1	Chapter 13, “Serial Peripheral Interface (S08SPIV3)”
PTC3–PTC0	KBI2P3–KBI2P0	Chapter 9, “Keyboard Interrupt (S08KBIV1)”
PTD6	TPM1CH0	Chapter 10, “Timer/PWM Module (S08TPMV1)”
PTD5 PTD4	ACMP1+ ACMP1–	Chapter 14, “Analog Comparator (S08ACMPV1)”
PTD2	IRQ	Chapter 5, “Resets, Interrupts, and System Configuration”
PTD1	RESET	
PTD0	BKGD/MS	
PTE7–PTE0	—	Chapter 6, “Parallel Input/Output”

1. See this chapter for information about modules that share these pins.

When an on-chip peripheral system is controlling a pin, data direction control bits still determine what is read from port data registers even though the peripheral module controls the pin direction by controlling the enable for the pin’s output buffer. See the Chapter 6, “Parallel Input/Output,” for more details.

Pullup enable bits for each input pin control whether on-chip pullup devices are enabled whenever the pin is acting as an input even if it is being controlled by an on-chip peripheral module. When the PTA7–PTA4 pins are controlled by the KBI module and are configured for rising-edge/high-level sensitivity, the pullup enable control bits enable pulldown devices rather than pullup devices. Similarly, when PTD2 is configured as the IRQ input and is set to detect rising edges, the pullup enable control bit enables a pulldown device rather than a pullup device.

2.3.7 Signal Properties Summary

Table 2-2 summarizes I/O pin characteristics. These characteristics are determined by the way the common pin interfaces are hardwired to internal circuits.

6.6.1 Port A Registers (PTAD, PTAPE, and PTADD)

Port A pins used as general-purpose I/O pins are controlled by the port A data (PTAD), data direction (PTADD), and pullup enable (PTAPE) registers.

	7	6	5	4	3	2	1	0
R W	PTAD7	PTAD6	PTAD5	PTAD4	PTAD3	PTAD2	PTAD1	PTAD0
Reset	0	0	0	0	0	0	0	0

Figure 6-6. Port A Data Register (PTAD)

Table 6-1. PTAD Field Descriptions

Field	Description
7:0 PTAD[7:0]	**Port A Data Register Bits** — For port A pins that are inputs, reads of this register return the logic level on the pin. For port A pins that are configured as outputs, reads of this register return the last value written to this register. Writes are latched into all bits of this register. For port A pins that are configured as outputs, the logic level is driven out the corresponding MCU pin. Reset forces PTAD to all 0s, but these 0s are not driven out the corresponding pins because reset also configures all port pins as high-impedance inputs with pullups disabled.

	7	6	5	4	3	2	1	0
R W	PTAPE7	PTAPE6	PTAPE5	PTAPE4	PTAPE3	PTAPE2	PTAPE1	PTAPE0
Reset	0	0	0	0	0	0	0	0

Figure 6-7. Pullup Enable for Port A (PTAPE)

Table 6-2. PTAPE Field Descriptions

Field	Description
7:0 PTAPE[7:0]	**Pullup Enable for Port A Bits** — For port A pins that are inputs, these read/write control bits determine whether internal pullup devices are enabled provided the corresponding PTADDn is a logic 0. For port A pins that are configured as outputs, these bits are ignored and the internal pullup devices are disabled. When any of bits 7 through 4 of port A are enabled as KBI inputs and are configured to detect rising edges/high levels, the pullup enable bits enable pulldown rather than pullup devices. 0 Internal pullup device disabled. 1 Internal pullup device enabled.

7.5 HCS08 Instruction Set Summary

Instruction Set Summary Nomenclature

The nomenclature listed here is used in the instruction descriptions in Table 7-2.

Operators

( )	=	Contents of register or memory location shown inside parentheses
←	=	Is loaded with (read: “gets”)
&	=	Boolean AND
|	=	Boolean OR
⊕	=	Boolean exclusive-OR
×	=	Multiply
÷	=	Divide
:	=	Concatenate
+	=	Add
–	=	Negate (two’s complement)

CPU registers

A	=	Accumulator
CCR	=	Condition code register
H	=	Index register, higher order (most significant) 8 bits
X	=	Index register, lower order (least significant) 8 bits
PC	=	Program counter
PCH	=	Program counter, higher order (most significant) 8 bits
PCL	=	Program counter, lower order (least significant) 8 bits
SP	=	Stack pointer

Memory and addressing

M	=	A memory location or absolute data, depending on addressing mode
M:M + 0x0001	=	A 16-bit value in two consecutive memory locations. The higher-order (most significant) 8 bits are located at the address of M, and the lower-order (least significant) 8 bits are located at the next higher sequential address.

Condition code register (CCR) bits

V	=	Two’s complement overflow indicator, bit 7
H	=	Half carry, bit 4
I	=	Interrupt mask, bit 3
N	=	Negative indicator, bit 2
Z	=	Zero indicator, bit 1
C	=	Carry/borrow, bit 0 (carry out of bit 7)

CCR activity notation

–	=	Bit not affected

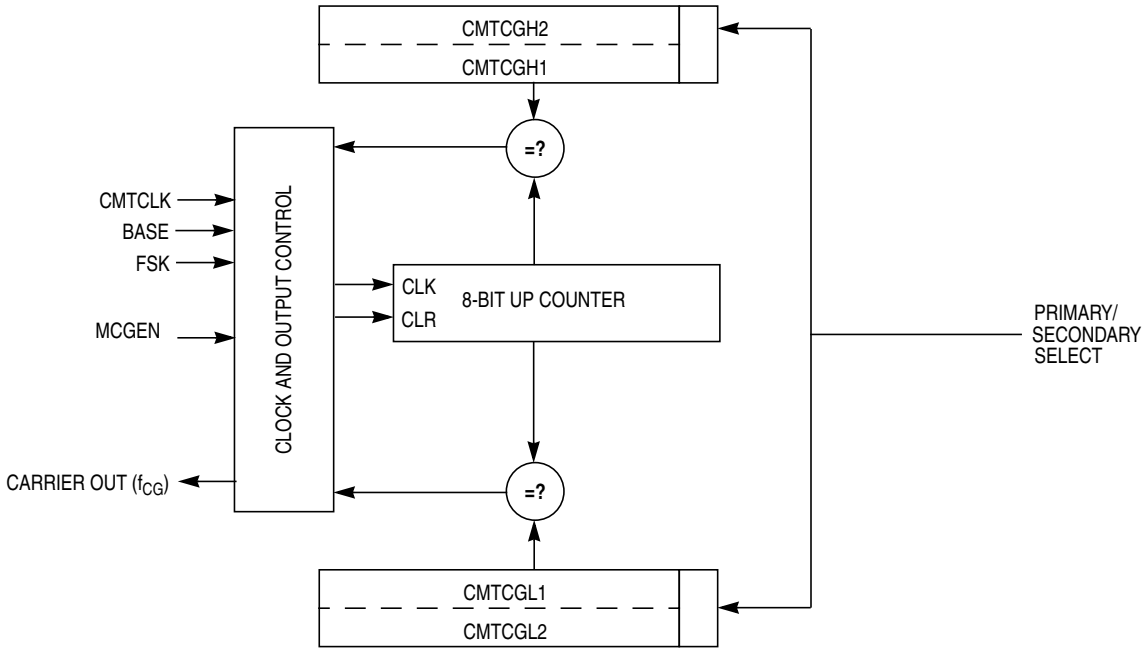


Figure 8-3. Carrier Generator Block Diagram

The high/low time counter is an 8-bit up counter. After each increment, the contents of the counter are compared with the appropriate high or low count value register. When the compare value is reached, the counter is reset to a value of $01, and the compare is redirected to the other count value register.

Assuming that the high time count compare register is currently active, a valid compare will cause the carrier output to be driven low. The counter will continue to increment (starting at reset value of $01). When the value stored in the selected low count value register is reached, the counter will again be reset and the carrier output will be driven high.

The cycle repeats, automatically generating a periodic signal that is directed to the modulator. The lowest frequency (maximum period) and highest frequency (minimum period) that can be generated are defined as:

$$f_{max} = f_{CMTCLK} \div (2 \times 1) \text{ Hz} \qquad \textit{Eqn. 8-1}$$

$$f_{min} = f_{CMTCLK} \div (2 \times (2^8 - 1)) \text{ Hz} \qquad \textit{Eqn. 8-2}$$

In the general case, the carrier generator output frequency is:

$$f_{CG} = f_{CMTCLK} \div (\text{Highcount} + \text{Lowcount}) \text{ Hz} \qquad \textit{Eqn. 8-3}$$

Where: $0 < \textit{Highcount} < 256$ and
$0 < \textit{Lowcount} < 256$

The duty cycle of the carrier signal is controlled by varying the ratio of high time to low + high time. As the input clock period is fixed, the duty cycle resolution will be proportional to the number of counts required to generate the desired carrier period.

$$\text{Duty Cycle} = \frac{\text{Highcount}}{\text{Highcount} + \text{Lowcount}} \qquad \textit{Eqn. 8-4}$$

8.5.2 Modulator

The modulator has three main modes of operation:

- Gate the carrier onto the modulator output (time mode)
- Control the logic level of the modulator output (baseband mode)
- Count carrier periods and instruct the carrier generator to alternate between two carrier frequencies whenever a modulation period (mark + space counts) expires (FSK mode)

The modulator includes a 17-bit down counter with underflow detection. The counter is loaded from the 16-bit modulation mark period buffer registers, CMTCMD1 and CMTCMD2. The most significant bit is loaded with a logic zero and serves as a sign bit. When the counter holds a positive value, the modulator gate is open and the carrier signal is driven to the transmitter block.

When the counter underflows, the modulator gate is closed and a 16-bit comparator is enabled that compares the logical complement of the value of the down-counter with the contents of the modulation space period register (which has been loaded from the registers CMTCMD3 and CMTCMD4).

When a match is obtained the cycle repeats by opening the modulator gate, reloading the counter with the contents of CMTCMD1 and CMTCMD2, and reloading the modulation space period register with the contents of CMTCMD3 and CMTCMD4.

If the contents of the modulation space period register are all zeroes, the match will be immediate and no space period will be generated (for instance, for FSK protocols that require successive bursts of different frequencies).

The MCGEN bit in the CMTMSC register must be set to enable the modulator timer.

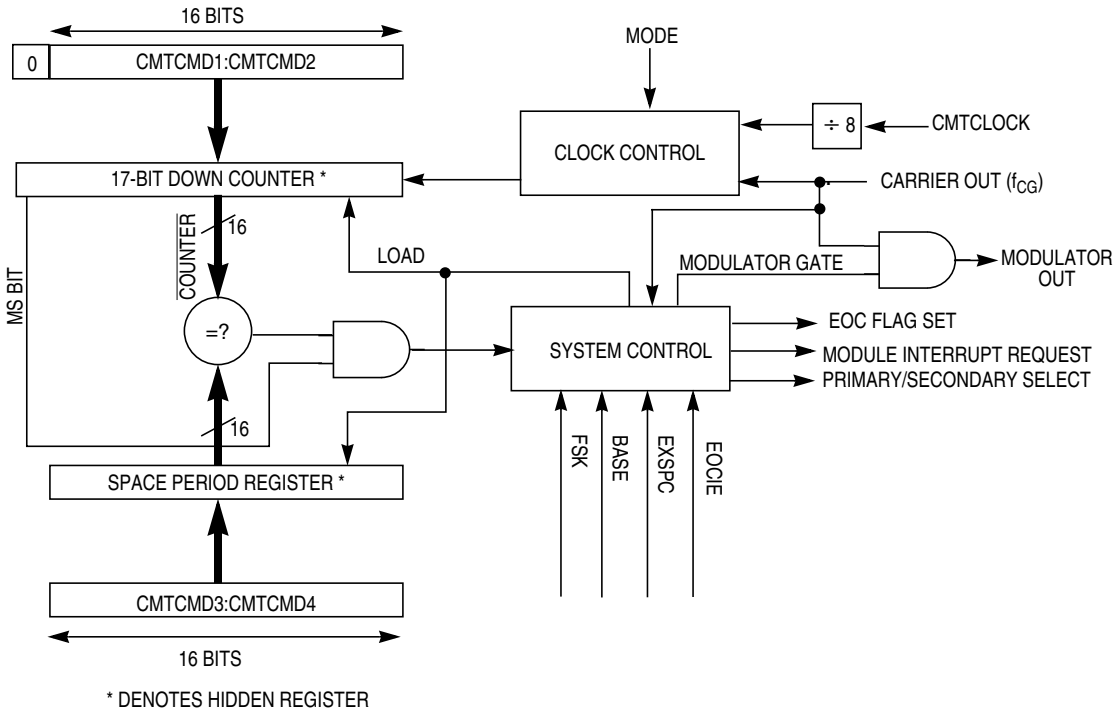


Figure 8-4. Modulator Block Diagram

8.5.2.1 Time Mode

When the modulator operates in time mode (MCGEN bit is set, BASE bit is clear, and FSK bit is clear), the modulation mark period consists of an integer number of CMTCLK ÷ 8 clock periods. The modulation space period consists of zero or an integer number of CMTCLK ÷ 8 clock periods. With an 8 MHz bus and CMTDIV1:CMTDIV0 = 00, the modulator resolution is 1 µs and has a maximum mark and space period of about 65.535 ms each. See Figure 8-5 for an example of the time mode and baseband mode outputs.

The mark and space time equations for time and baseband mode are:

$$t_{mark} = (CMTCMD1{:}CMTCMD2 + 1) \div (f_{CMTCLK} \div 8) \qquad \textit{Eqn. 8-5}$$

$$t_{space} = CMTCMD3{:}CMTCMD4 \div (f_{CMTCLK} \div 8) \qquad \textit{Eqn. 8-6}$$

where CMTCMD1:CMTCMD2 and CMTCMD3:CMTCMD4 are the decimal values of the concatenated registers.

NOTE

If the modulator is disabled while the t_{mark} time is less than the programmed carrier high time ($t_{mark} < CMTCGH1/f_{CMTCLK}$), the modulator can enter into an illegal state and end the curent cycle before the programmed value. Make sure to program t_{mark} greater than the carrier high time to avoid this illegal state.

$$t_{exspace} = t_{space} + (t_{mark} + t_{space}) \times (\text{number of modulation periods}) \quad \textit{Eqn. 8-9}$$

For an example of extended space operation, see Figure 8-7.

NOTE

The EXSPC feature can be used to emulate a zero mark event.

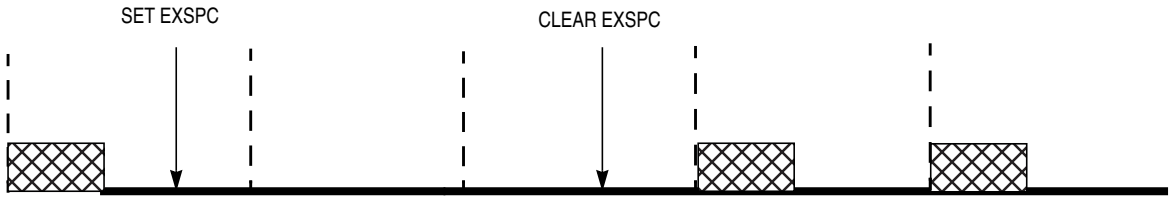


Figure 8-7. Extended Space Operation

8.5.3.2 EXSPC Operation in FSK Mode

In FSK mode, the modulator continues to count carrier out clocks, alternating between the primary and secondary registers at the end of each modulation period.

To calculate the length of an extended space in FSK mode, the user must know whether the EXSPC bit was set on a primary or secondary modulation period, as well as the total number of both primary and secondary modulation periods completed while the EXSPC bit is high. A status bit for the current modulation is not accessible to the CPU. If necessary, software should maintain tracking of the current modulation cycle (primary or secondary). The extended space period ends at the completion of the space period time of the modulation period during which the EXSPC bit is cleared.

If the EXSPC bit was set during a primary modulation cycle, use the equation:

$$t_{exspace} = (t_{space})_p + (t_{mark} + t_{space})_s + (t_{mark} + t_{space})_p + \ldots \quad \textit{Eqn. 8-10}$$

Where the subscripts p and s refer to mark and space times for the primary and secondary modulation cycles.

If the EXSPC bit was set during a secondary modulation cycle, use the equation:

$$t_{exspace} = (t_{space})_s + (t_{mark} + t_{space})_p + (t_{mark} + t_{space})_s + \ldots \quad \textit{Eqn. 8-11}$$

8.5.4 Transmitter

The transmitter output block controls the state of the infrared out pin (IRO). The modulator output is gated on to the IRO pin when the modulator/carrier generator is enabled. When the modulator/carrier generator is disabled, the IRO pin is controlled by the state of the IRO latch.

A polarity bit in the CMTOC register enables the IRO pin to be high true or low true.

Chapter 10
Timer/PWM Module (S08TPMV1)

10.1 Introduction

The MC9S08RC/RD/RE/RG includes a timer/PWM (TPM) module that supports traditional input capture, output compare, or buffered edge-aligned pulse-width modulation (PWM) on each channel. A control bit in the TPM configures both channels in the timer to operate as center-aligned PWM functions. Timing functions in the TPM are based on a 16-bit counter with prescaler and modulo features to control frequency and range (period between overflows) of the time reference. This timing system is ideally suited for a wide range of control applications. The MC9S08RC/RD/RE/RG devices do not have a separate fixed internal clock source (XCLK). If the XCLK source is selected using the CLKSA and CLKSB control bits (see Table 10-2), the TPM will use the BUSCLK.

10.2 Features

Timer system features include:

- Two separate channels:
  - Each channel may be input capture, output compare, or buffered edge-aligned PWM
  - Rising-edge, falling-edge, or any-edge input capture trigger
  - Set, clear, or toggle output compare action
  - Selectable polarity on PWM outputs
- The TPM may be configured for buffered, center-aligned pulse-width modulation (CPWM) on both channels
- Clock source to prescaler for the TPM is selectable between the bus clock or an external pin:
  - Prescale taps for divide by 1, 2, 4, 8, 16, 32, 64, or 128
  - External clock input shared with TPM1CH0 timer channel pin
- 16-bit modulus register to control counter range
- Timer system enable
- One interrupt per channel plus terminal count interrupt

output compare, and edge-aligned PWM functions. The timer counter modulo registers, TPM1MODH:TPM1MODL, control the modulo value of the counter. (The values $0000 or $FFFF effectively make the counter free running.) Software can read the counter value at any time without affecting the counting sequence. Any write to either byte of the TPM1CNT counter resets the counter regardless of the data value written.

All TPM channels are programmable independently as input capture, output compare, or buffered edge-aligned PWM channels.

10.4 Pin Descriptions

Table 10-2 shows the MCU pins related to the TPM module. When TPM1CH0 is used as an external clock input, the associated TPM channel 0 can not use the pin. (Channel 0 can still be used in output compare mode as a software timer.) When any of the pins associated with the timer is configured as a timer input, a passive pullup can be enabled. After reset, the TPM modules are disabled and all pins default to general-purpose inputs with the passive pullups disabled.

10.4.1 External TPM Clock Sources

When control bits CLKSB:CLKSA in the timer status and control register are set to 1:1, the prescaler and consequently the 16-bit counter for TPM1 are driven by an external clock source connected to the TPM1CH0 pin. A synchronizer is needed between the external clock and the rest of the TPM. This synchronizer is clocked by the bus clock so the frequency of the external source must be less than one-half the frequency of the bus rate clock. The upper frequency limit for this external clock source is specified to be one-fourth the bus frequency to conservatively accommodate duty cycle and phase-locked loop (PLL) or frequency-locked loop (FLL) frequency jitter effects.

When the TPM is using the channel 0 pin for an external clock, the corresponding ELS0B:ELS0A control bits should be set to 0:0 so channel 0 is not trying to use the same pin.

10.4.2 TPM1CHn — TPM1 Channel n I/O Pins

Each TPM channel is associated with an I/O pin on the MCU. The function of this pin depends on the configuration of the channel. In some cases, no pin function is needed so the pin reverts to being controlled by general-purpose I/O controls. When a timer has control of a port pin, the port data and data direction registers do not affect the related pin(s). See the Pins and Connections chapter for additional information about shared pin functions.

10.5 Functional Description

All TPM functions are associated with a main 16-bit counter that allows flexible selection of the clock source and prescale divisor. A 16-bit modulo register also is associated with the main 16-bit counter in the TPM. Each TPM channel is optionally associated with an MCU pin and a maskable interrupt function.

The TPM has center-aligned PWM capabilities controlled by the CPWMS control bit in TPM1SC. When CPWMS is set to 1, timer counter TPM1CNT changes to an up-/down-counter and all channels in the associated TPM act as center-aligned PWM channels. When CPWMS = 0, each channel can

independently be configured to operate in input capture, output compare, or buffered edge-aligned PWM mode.

The following sections describe the main 16-bit counter and each of the timer operating modes (input capture, output compare, edge-aligned PWM, and center-aligned PWM). Because details of pin operation and interrupt activity depend on the operating mode, these topics are covered in the associated mode sections.

10.5.1 Counter

All timer functions are based on the main 16-bit counter (TPM1CNTH:TPM1CNTL). This section discusses selection of the clock source, up-counting vs. up-/down-counting, end-of-count overflow, and manual counter reset.

After any MCU reset, CLKSB:CLKSA = 0:0 so no clock source is selected and the TPM is inactive. Normally, CLKSB:CLKSA would be set to 0:1 so the bus clock drives the timer counter. The clock source for the TPM can be selected to be off, the bus clock (BUSCLK), the fixed system clock (XCLK), or an external input through the TPM1CH0 pin. The maximum frequency allowed for the external clock option is one-fourth the bus rate. Refer to Section 10.7.1, “Timer Status and Control Register (TPM1SC),” and Table 10-2 for more information about clock source selection.

When the microcontroller is in active background mode, the TPM temporarily suspends all counting until the microcontroller returns to normal user operating mode. During stop mode, all TPM clocks are stopped; therefore, the TPM is effectively disabled until clocks resume. During wait mode, the TPM continues to operate normally.

The main 16-bit counter has two counting modes. When center-aligned PWM is selected (CPWMS = 1), the counter operates in up-/down-counting mode. Otherwise, the counter operates as a simple up-counter. As an up-counter, the main 16-bit counter counts from $0000 through its terminal count and then continues with $0000. The terminal count is $FFFF or a modulus value in TPM1MODH:TPM1MODL.

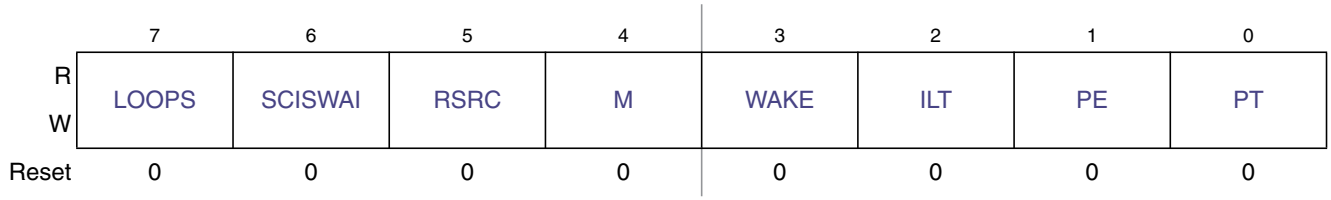
When center-aligned PWM operation is specified, the counter counts upward from $0000 through its terminal count and then counts downward to $0000 where it returns to up-counting. Both $0000 and the terminal count value (value in TPM1MODH:TPM1MODL) are normal length counts (one timer clock period long).

An interrupt flag and enable are associated with the main 16-bit counter. The timer overflow flag (TOF) is a software-accessible indication that the timer counter has overflowed. The enable signal selects between software polling (TOIE = 0) where no hardware interrupt is generated, or interrupt-driven operation (TOIE = 1) where a static hardware interrupt is automatically generated whenever the TOF flag is 1.

The conditions that cause TOF to become set depend on the counting mode (up or up/down). In up-counting mode, the main 16-bit counter counts from $0000 through $FFFF and overflows to $0000 on the next counting clock. TOF becomes set at the transition from $FFFF to $0000. When a modulus limit is set, TOF becomes set at the transition from the value set in the modulus register to $0000. When the main 16-bit counter is operating in up-/down-counting mode, the TOF flag gets set as the counter changes direction at the transition from the value set in the modulus register and the next lower count value. This corresponds to the end of a PWM period. (The $0000 count value corresponds to the center of a period.)

12.2.2 SCI Control Register 1 (SCI1C1)

This read/write register is used to control various optional features of the SCI system.



	7	6	5	4	3	2	1	0
R W	LOOPS	SCISWAI	RSRC	M	WAKE	ILT	PE	PT
Reset	0	0	0	0	0	0	0	0

Figure 12-5. SCI Control Register 1 (SCI1C1)

Table 12-3. SCI1C1 Register Field Descriptions

Field	Description
7 LOOPS	**Loop Mode Select** — Selects between loop back modes and normal 2-pin full-duplex modes. When LOOPS = 1, the transmitter output is internally connected to the receiver input. 0 Normal operation — RxD and TxD use separate pins. 1 Loop mode or single-wire mode where transmitter outputs are internally connected to receiver input. (See RSRC bit.) RxD pin is not used by SCI.
6 SCISWAI	**SCI Stops in Wait Mode** 0 SCI clocks continue to run in wait mode so the SCI can be the source of an interrupt that wakes up the CPU. 1 SCI clocks freeze while CPU is in wait mode.
5 RSRC	**Receiver Source Select** — This bit has no meaning or effect unless the LOOPS bit is set to 1. When LOOPS = 1, the receiver input is internally connected to the TxD pin and RSRC determines whether this connection is also connected to the transmitter output. 0 Provided LOOPS = 1, RSRC = 0 selects internal loop back mode and the SCI does not use the RxD pins. 1 Single-wire SCI mode where the TxD pin is connected to the transmitter output and receiver input.
4 M	**9-Bit or 8-Bit Mode Select** 0 Normal — start + 8 data bits (LSB first) + stop. 1 Receiver and transmitter use 9-bit data characters start + 8 data bits (LSB first) + 9th data bit + stop.
3 WAKE	**Receiver Wakeup Method Select** — Refer to Section 12.3.3.2, “Receiver Wakeup Operation” for more information. 0 Idle-line wakeup. 1 Address-mark wakeup.
2 ILT	**Idle Line Type Select** — Setting this bit to 1 ensures that the stop bit and logic 1 bits at the end of a character do not count toward the 10 or 11 bit times of the logic high level by the idle line detection logic. Refer to Section 12.3.3.2.1, “Idle-Line Wakeup” for more information. 0 Idle character bit count starts after start bit. 1 Idle character bit count starts after stop bit.
1 PE	**Parity Enable** — Enables hardware parity generation and checking. When parity is enabled, the most significant bit (MSB) of the data character (eighth or ninth data bit) is treated as the parity bit. 0 No hardware parity generation or checking. 1 Parity enabled.
0 PT	**Parity Type** — Provided parity is enabled (PE = 1), this bit selects even or odd parity. Odd parity means the total number of 1s in the data character, including the parity bit, is odd. Even parity means the total number of 1s in the data character, including the parity bit, is even. 0 Even parity. 1 Odd parity.

12.3.3.2.1 Idle-Line Wakeup

When WAKE = 0, the receiver is configured for idle-line wakeup. In this mode, RWU is cleared automatically when the receiver detects a full character time of the idle-line level. The M control bit selects 8-bit or 9-bit data mode that determines how many bit times of idle are needed to constitute a full character time (10 or 11 bit times because of the start and stop bits). The idle-line type (ILT) control bit selects one of two ways to detect an idle line:

- When ILT = 0, the idle bit counter starts after the start bit so the stop bit and any logic 1s at the end of a character count toward the full character time of idle.
- When ILT = 1, the idle bit counter doesn't start until after a stop bit time, so the idle detection is not affected by the data in the last character of the previous message.

12.3.3.2.2 Address-Mark Wakeup

When WAKE = 1, the receiver is configured for address-mark wakeup. In this mode, RWU is cleared automatically when the receiver detects a logic 1 in the most significant bit of a received character (eighth bit in M = 0 mode and ninth bit in M = 1 mode).

12.3.4 Interrupts and Status Flags

The SCI system has three separate interrupt vectors to reduce the amount of software needed to isolate the cause of the interrupt. One interrupt vector is associated with the transmitter for TDRE and TC events. Another interrupt vector is associated with the receiver for RDRF and IDLE events, and a third vector is used for OR, NF, FE, and PF error conditions. Each of these eight interrupt sources can be separately masked by local interrupt enable masks. The flags can still be polled by software when the local masks are cleared to disable generation of hardware interrupt requests.

The SCI transmitter has two status flags that optionally can generate hardware interrupt requests. Transmit data register empty (TDRE) indicates when there is room in the transmit data buffer to write another transmit character to SCI1D. If the transmit interrupt enable (TIE) bit is set, a hardware interrupt will be requested whenever TDRE = 1. Transmit complete (TC) indicates that the transmitter is finished transmitting all data, preamble, and break characters and is idle with TxD1 high. This flag is often used in systems with modems to determine when it is safe to turn off the modem. If the transmit complete interrupt enable (TCIE) bit is set, a hardware interrupt will be requested whenever TC = 1. Instead of hardware interrupts, software polling may be used to monitor the TDRE and TC status flags if the corresponding TIE or TCIE local interrupt masks are 0s.

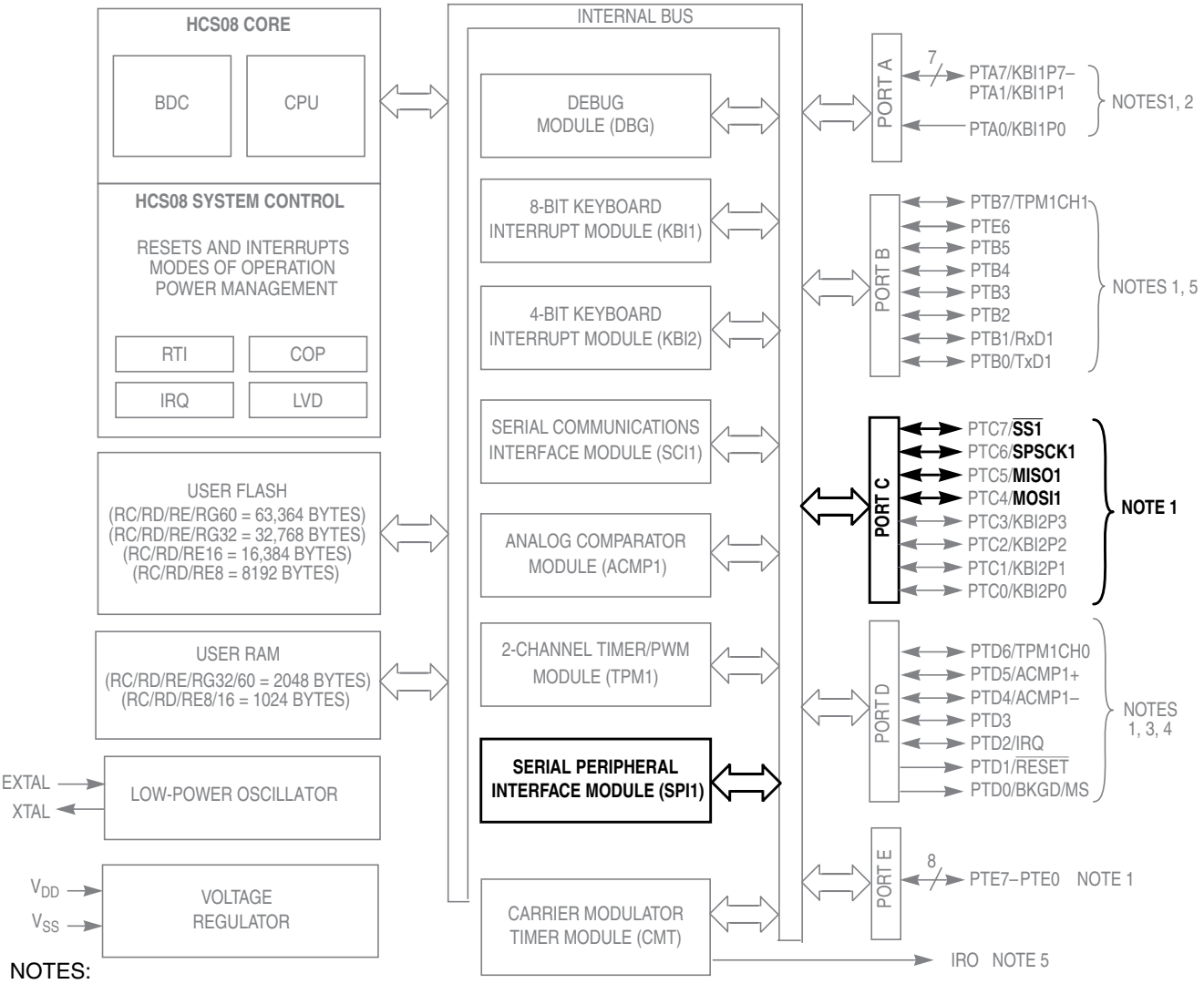
When a program detects that the receive data register is full (RDRF = 1), it gets the data from the receive data register by reading SCI1D. The RDRF flag is cleared by reading SCI1S1 while RDRF = 1 and then reading SCI1D.

When polling is used, this sequence is naturally satisfied in the normal course of the user program. If hardware interrupts are used, SCI1S1 must be read in the interrupt service routine (ISR). Normally, this is done in the ISR anyway to check for receive errors, so the sequence is automatically satisfied.

The IDLE status flag includes logic that prevents it from getting set repeatedly when the RxD1 line remains idle for an extended period of time. IDLE is cleared by reading SCI1S1 while IDLE = 1 and then reading

Chapter 13
Serial Peripheral Interface (S08SPIV3)

The SPI is only available on the MC9S08RGxx versions of this family of microcontrollers. The SPI pins are shared with PTC4-PTC7 port pins. When the SPI is enabled these pins are controlled by the SPI module.



NOTES:
1. Port pins are software configurable with pullup device if input port
2. PTA0 does not have a clamp diode to VDD. PTA0 should not be driven above VDD. Also, PTA0 does not pullup to VDD when internal pullup is enabled.
3. IRQ pin contains software configurable pullup/pulldown device if IRQ enabled (IRQPE = 1)
4. The RESET pin contains integrated pullup device enabled if reset enabled (RSTPE = 1)
5. High current drive
6. Pins PTA[7:4] contain both pullup and pulldown devices. Pulldown enabled when KBI is enabled (KBIPEn = 1) and rising edge is selected (KBEDGn = 1).

Figure 13-1. MC9S08RC/RD/RE/RG Block Diagram Highlighting SPI Block and Pins

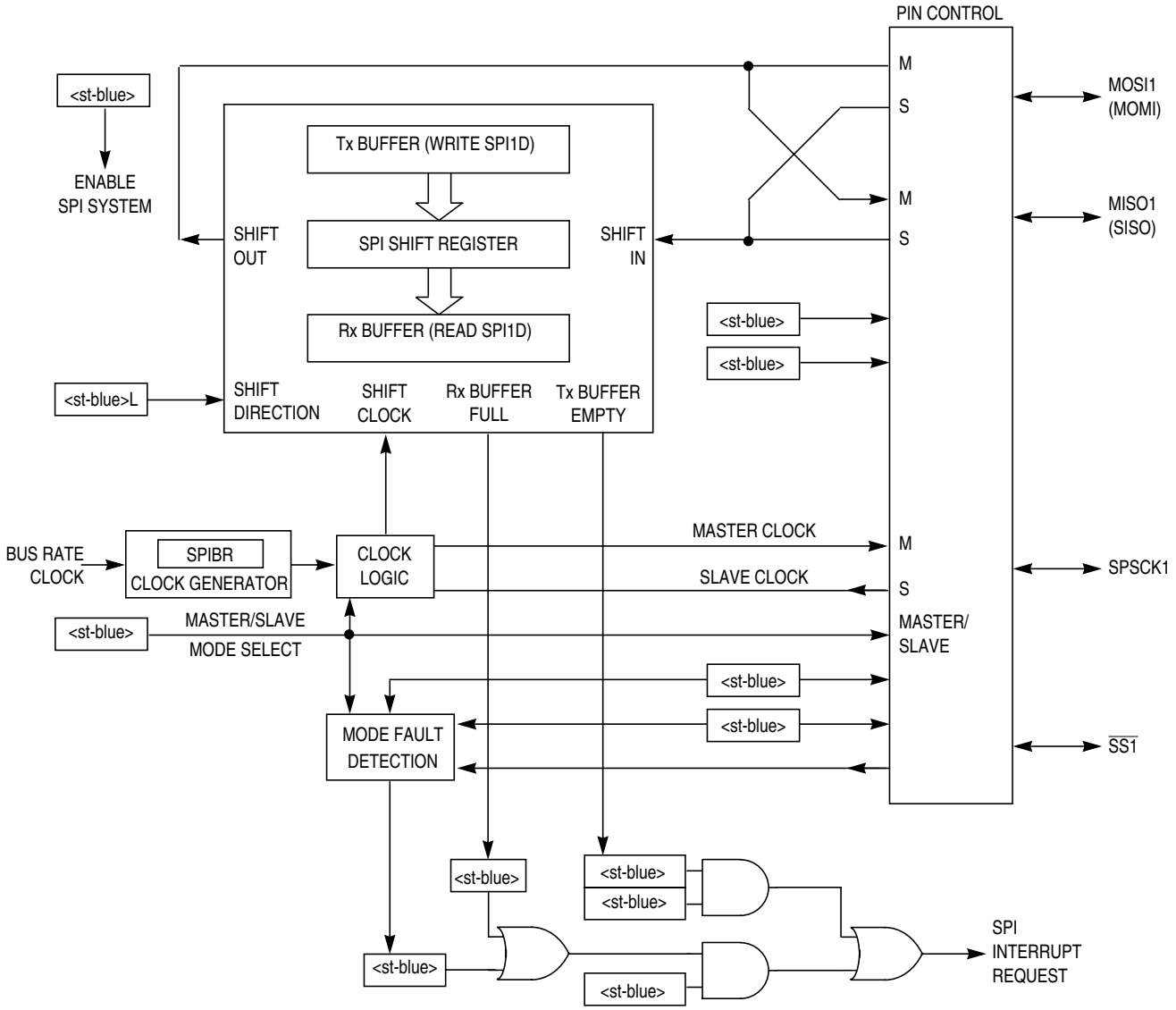


Figure 13-3. SPI Module Block Diagram

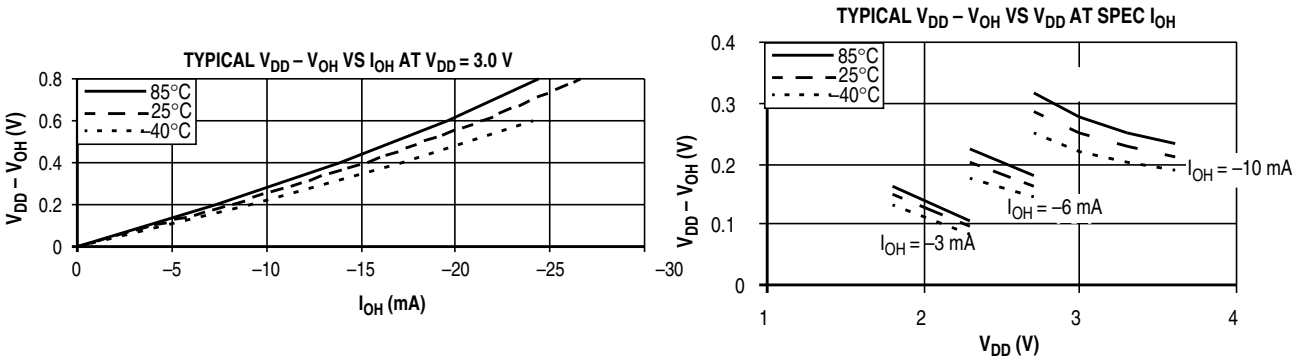


Figure A-4. Typical High-Side Driver (Source) Characteristics (Port B and IRO)

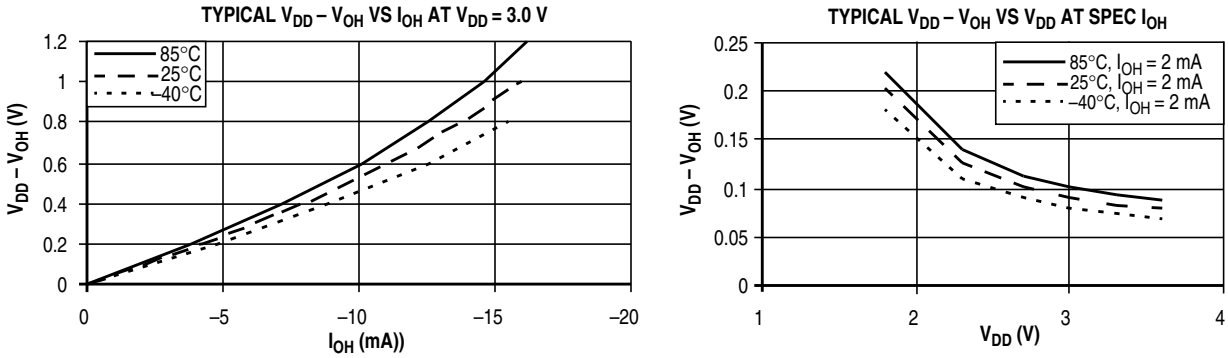


Figure A-5. Typical High-Side (Source) Characteristics (Ports A, C, D and E)

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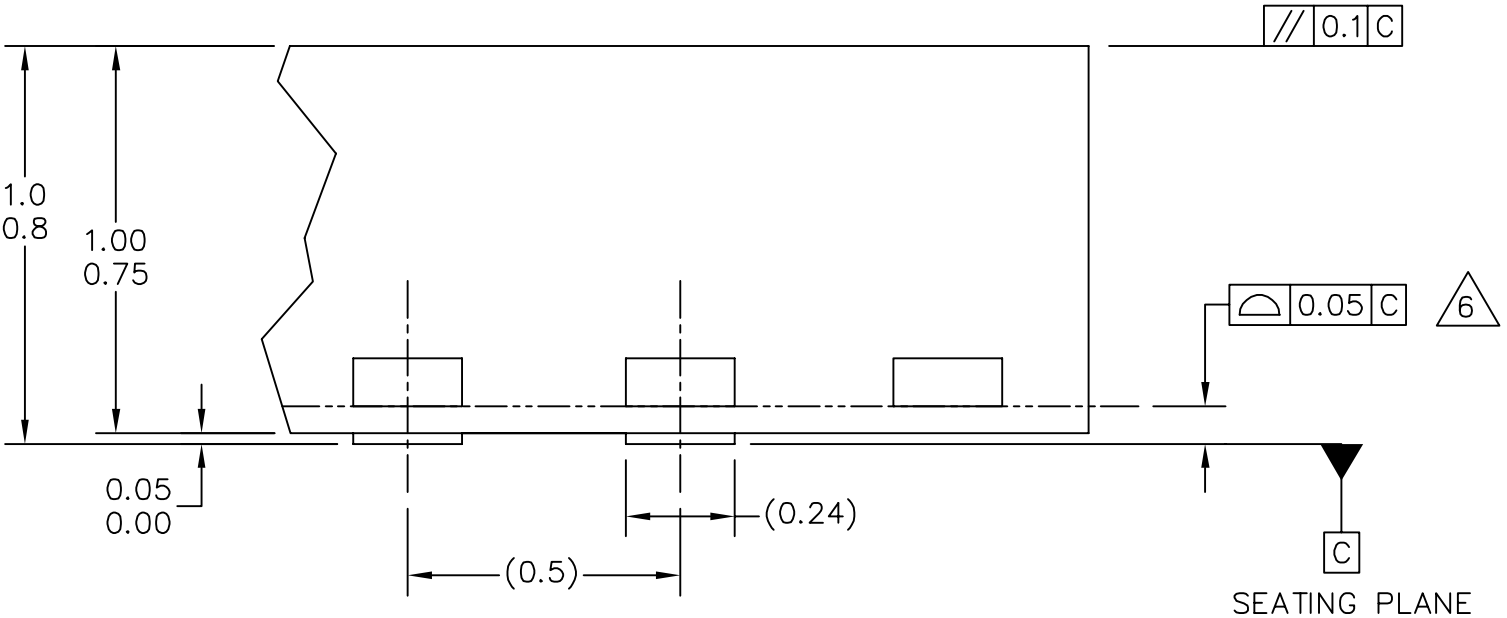
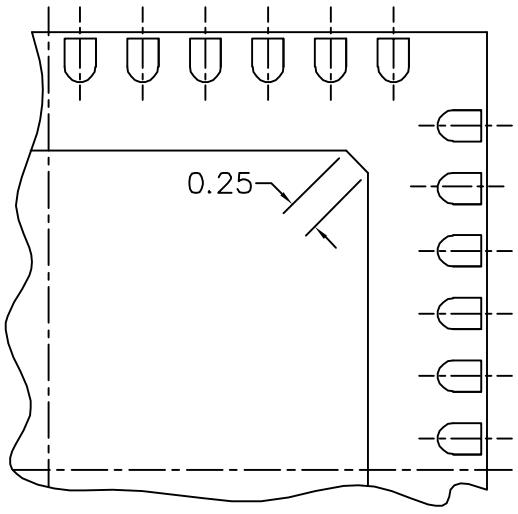
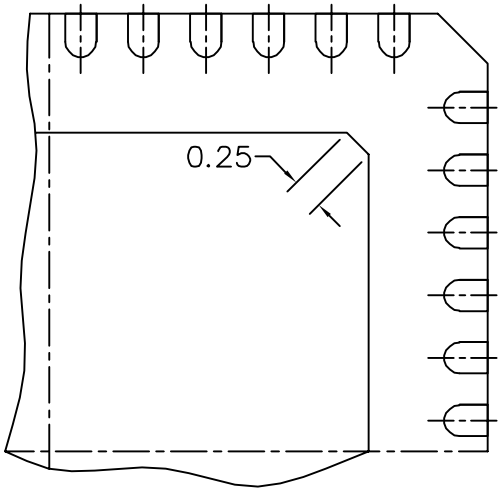


DETAIL G
VIEW ROTATED 90° CW



DETAIL M
PREFERED PIN 1 BACKSIDE IDENTIFIER



DETAIL M
PIN 1 BACKSIDE IDENTIFIER OPTION1

TITLE: THERMALLY ENHANCED QUAD FLAT NON-LEADED PACKAGE (QFN) 48 TERMINAL, 0.5 PITCH (7 X 7 X 1)

CASE NUMBER: 1314-03
STANDARD: JEDEC-MO-220 VKKD-2
PACKAGE CODE: 6152

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